HMC542LP4 / 542LP4E

v02.0108

0.5 dB LSB GaAs MMIC 6-BIT DIGITAL SERIAL CONTROL ATTENUATOR, DC - 3 GHz

Typical Applications

The HMC542LP4 / HMC542LP4E is ideal for both RF and IF applications:

- Cellular/PCS/3G Infrastructure
- ISM, MMDS, WLAN, WiMAX, & WiBro
- Microwave Radio & VSAT
- Test Equipment and Sensors

Features

0.5 dB LSB Steps to 31.5 dB

TTL/CMOS Compatible Serial Data Interface

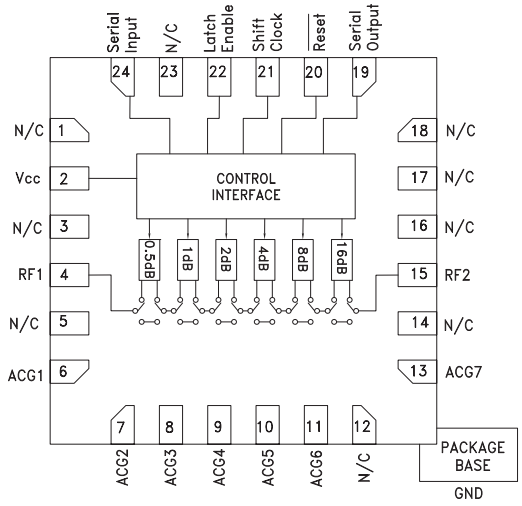
SPI Compatible Serial Output

± 0.25 dB Typical Step Error

Single +5V Supply

4x4 mm SMT Package

Functional Diagram



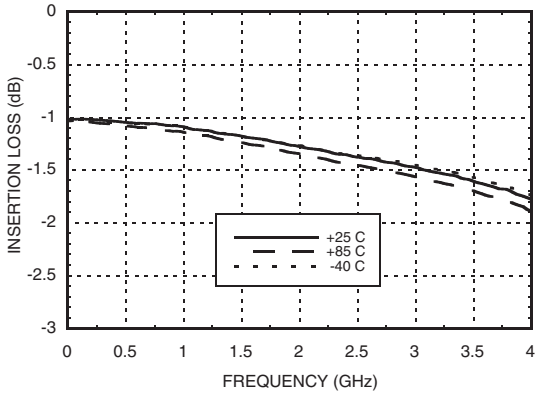
General Description

The HMC542LP4 & HMC542LP4E are broadband 6-bit GaAs IC digital attenuators with CMOS compatible serial to parallel drivers in low cost leadless surface mount packages. This serial control digital attenuator incorporates off chip AC ground capacitors for near DC operation, making it suitable for a wide variety of RF and IF applications. Covering DC to 3 GHz, the insertion loss is 1.5 dB and the attenuator bit values are 0.5 (LSB), 1, 2, 4, 8, and 16 dB for a total attenuation of 31.5 dB. Attenuation accuracy is excellent at ± 0.25 dB typical step error with an IIP3 of +45 dBm. Six bit serial control words are used to select each attenuation state. A single Vdd bias of +5V is required.

Electrical Specifications, T_A = +25° C, With Vcc = +5V

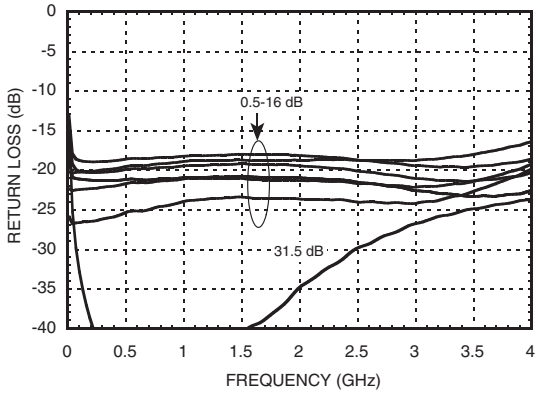
Parameter	Frequency (GHz)	Min.	Typ.	Max.	Units
Insertion Loss	DC - 1.5 GHz 1.5 - 3.0 GHz		1.2 1.5	1.5 1.8	dB dB
Attenuation Range	DC - 3 GHz		31.5		dB
Return Loss (RF1 & RF2, All Atten. States)	DC - 3 GHz		17		dB
Attenuation Accuracy: (Referenced to Insertion Loss) All Attenuation States 0.5 - 3.5 dB States 4.0 - 31.5 dB States All Attenuation States	 DC - 1.0 GHz 1.0 - 2.2 GHz 1.0 - 2.2 GHz 2.2 - 3.0 GHz	 ± (0.20 + 3% of Atten. Setting) Max. ± (0.25 + 3% of Atten. Setting) Max. ± (0.15 + 4% of Atten. Setting) Max. ± (0.30 + 3% of Atten. Setting) Max.			 dB dB dB dB
Input Power for 0.1 dB Compression	0.1 - 3.0 GHz		20		dBm
Input Third Order Intercept Point (Two-Tone Input Power= 0 dBm Each Tone)	0.1 - 1.5 GHz 1.5 - 3.0 GHz		35 45		dBm dBm
Switching Characteristics tRISE, tFALL (10/90% RF) tON, tOFF (50% CTL to 10/90% RF)	DC - 3 GHz		 800 900		 ns ns

Insertion Loss



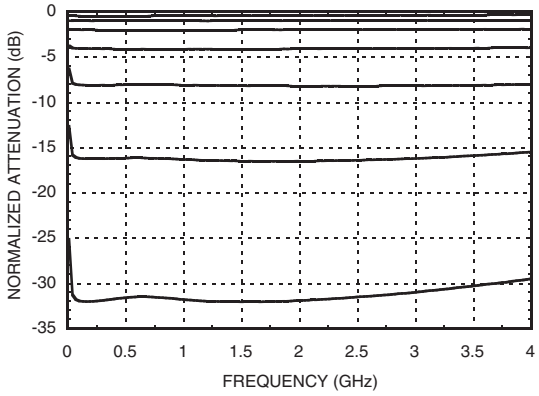
Return Loss RF1, RF2

(Only Major States are Shown)

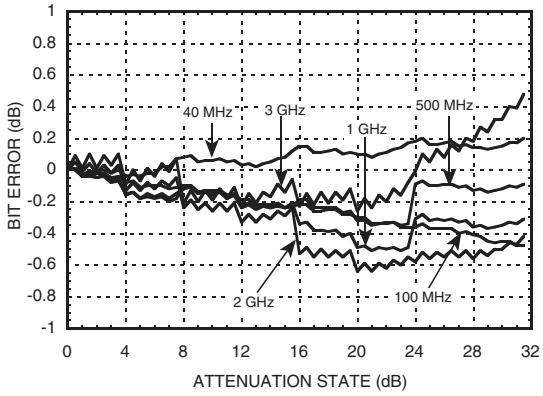


Normalized Attenuation

(Only Major States are Shown)

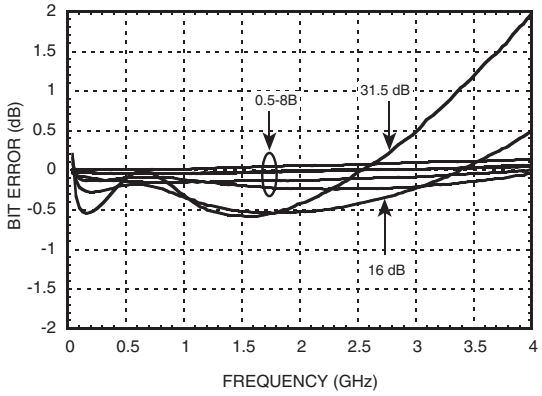


Bit Error vs. Attenuation State



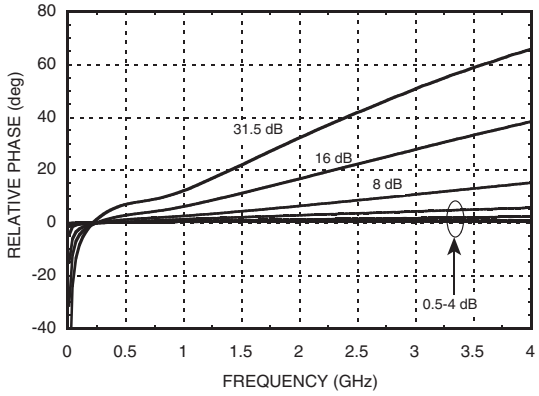
Bit Error vs. Frequency

(Only Major States are Shown)



Relative Phase vs. Frequency

(Only Major States are Shown)



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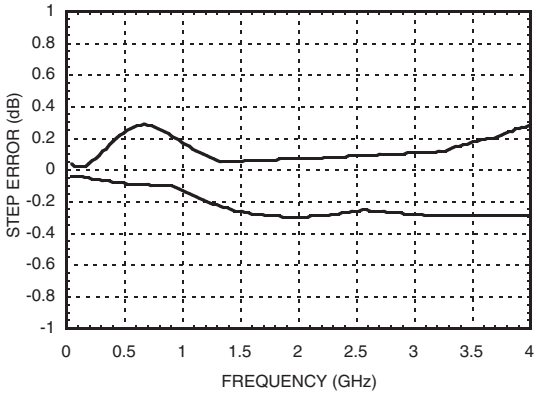
Worst Case Step Error Between Successive Attenuation States



Digital Control Voltages

State	Vcc = +5V
Low	0 to 1.3V
High	3.5 to 5.0V

Serial Input Truth Table

Latch Enable	Shift Clock	$\overline{\text{Reset}}$	Function
X	X	L	Shift register cleared
X	↑	H	Shift register clocked
↑	X	H	Contents of shift register transferrred to Digital Attenuator

Timing

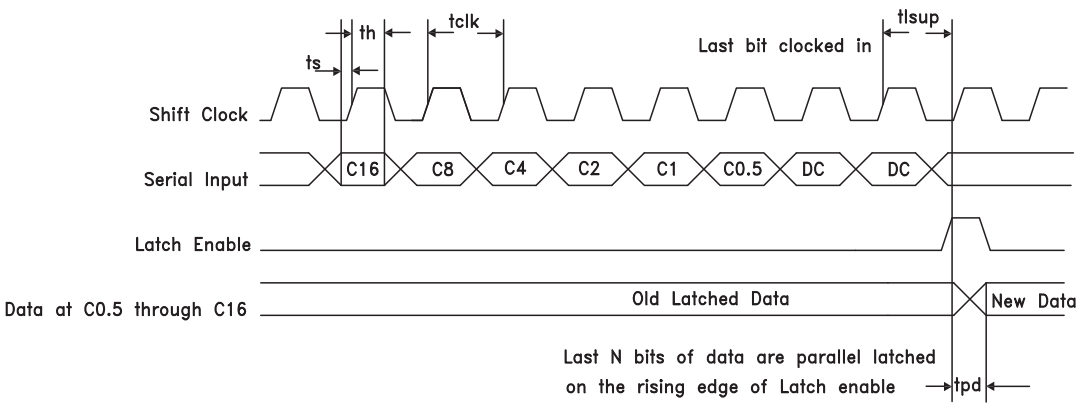
Parameter	Symbol	Vcc = +5V		Units
		Min.	Max.	
Serial Input Setup Time	ts	20	-	ns
Hold time from Serial Input to Shift Clock	th	0	-	ns
Setup time from Shift Clock to Latch Enable	tlsup	40	-	ns
Latch Enable Window, Latch Enable to C0.5 through C8	tpd	-	30	ns
Setup time from Reset to Shift Clock	-	20	-	ns
Clock Frequency (1/tclk)	fclk	-	30	MHz

Truth Table

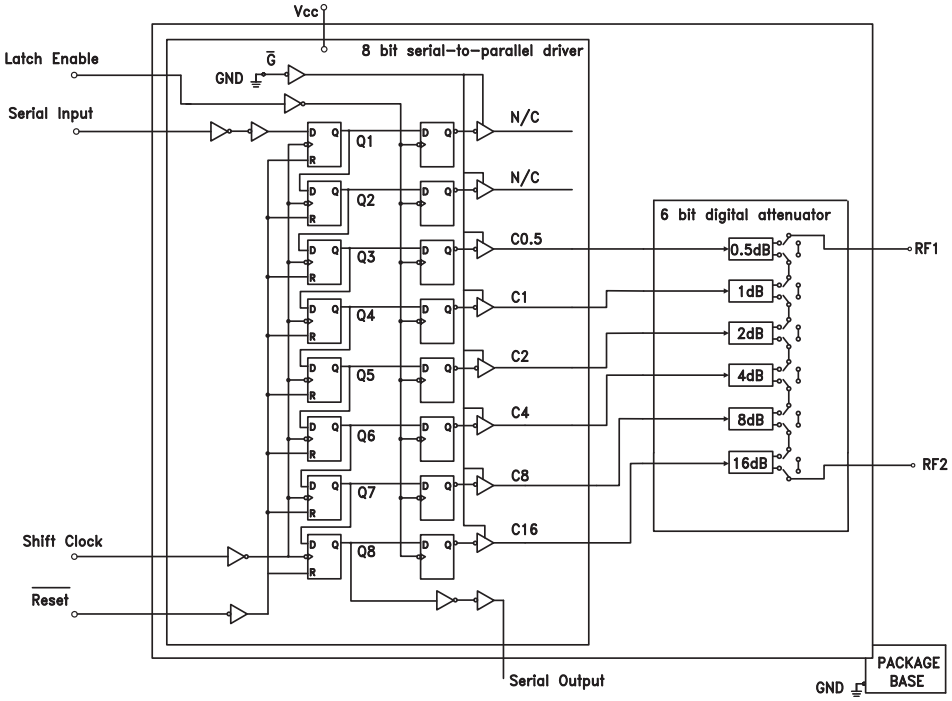
Control Voltage Input						Attenuation State RF1 - RF2
C16	C8	C4	C2	C1	C0.5	
High	High	High	High	High	High	Reference I.L.
High	High	High	High	High	Low	0.5 dB
High	High	High	High	Low	High	1 dB
High	High	High	Low	High	High	2 dB
High	High	Low	High	High	High	4 dB
High	Low	High	High	High	High	8 dB
Low	High	High	High	High	High	16 dB
Low	Low	Low	Low	Low	Low	31.5 dB
Any combination of the above states will provide an attenuation approximately equal to the sum of the bits selected.						

Timing Diagram

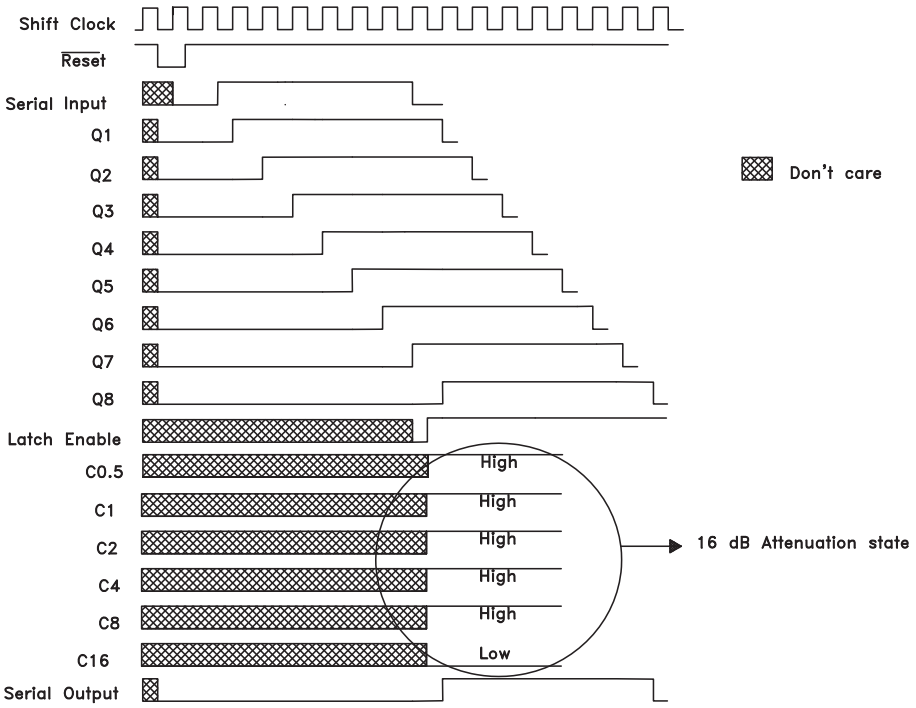
Serial data is shifted in on the rising edge of the Shift Clock, MSB first, and is latched on the rising edge of Latch Enable.



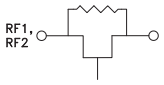
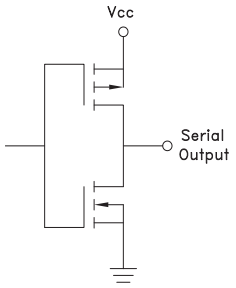
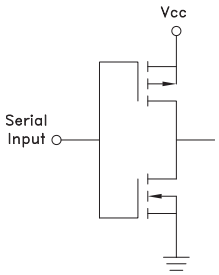
Logic / Functional Diagram



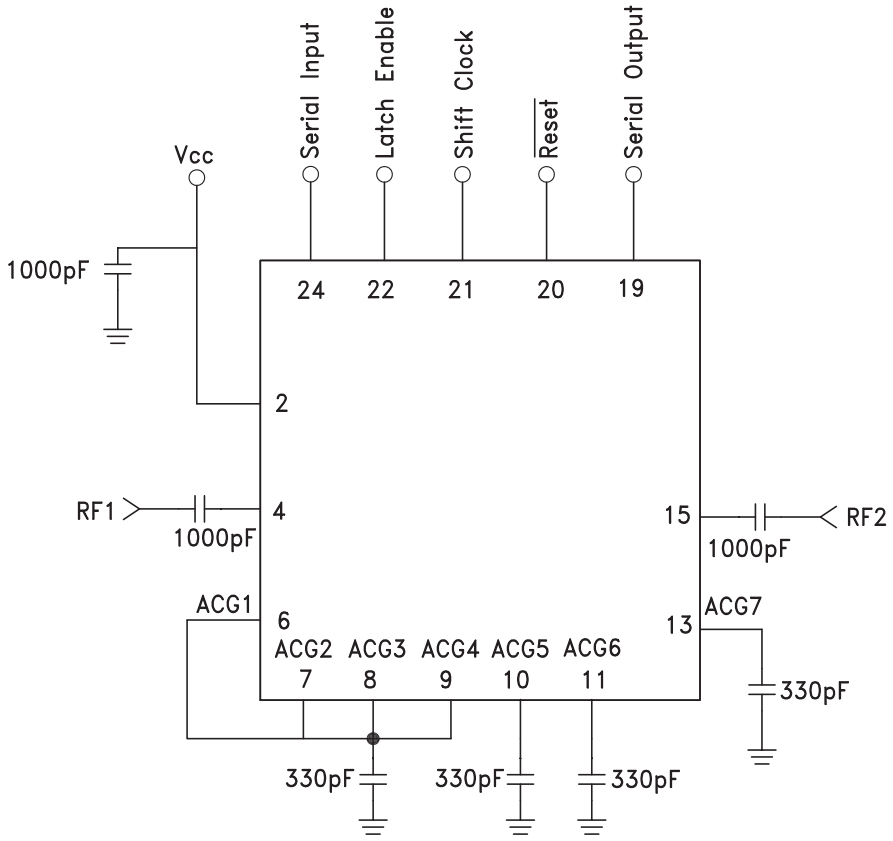
Programming Example to Select 16 dB Attenuation State



Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 3, 5, 12, 14, 16-18, 23	N/C	These pins should be connected to PCB RF ground to maximize performance.	
2	Vcc	Supply Voltage.	
4, 15	RF1, RF2	This pin is DC coupled and matched to 50 Ohms Blocking capacitors are required. Select value based on lowest frequency of operation.	
6 - 11, 13	ACG1 - ACG7	External capacitor to ground is required. Select value for lowest frequency of operation. Place capacitor as close to pins as possible.	
19	Serial Output	Serial data output. Serial input data delayed by 8 clock cycles	
20	$\overline{\text{Reset}}$	See truth table, control voltage table and timing diagram.	
21	Shift Clock		
22	Latch Enable		
24	Serial Input		
	GND	Package bottom has an exposed metal paddle that must be connected to RF/DC Ground.	

Application Circuit



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Absolute Maximum Ratings

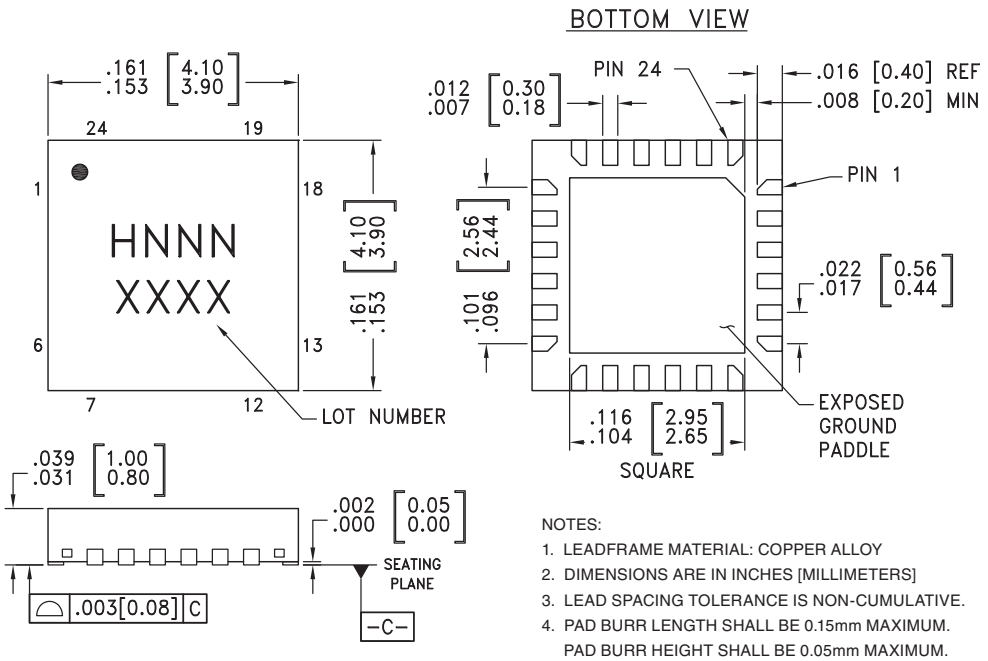
RF Input Power (DC - 3 GHz)	+27 dBm (T = +85 °C)
Digital Inputs (Reset, Shift Clock, Latch Enable & Serial Input)	-1.5 to (Vcc +1.5V) Vdc
Bias Voltage (Vcc)	+7.0 Vdc
Channel Temperature	150 °C
Continuous Pdiss (T = 85 °C) (derate 7.7 mW/°C above 85 °C)	0.5 W
Thermal Resistance	130 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C

Bias Voltage

Vcc (Vdc)	Idd (Typ.) (mA)
+4.5	4.7
+5.0	5.0
+5.5	5.3

ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS

Outline Drawing



NOTES:

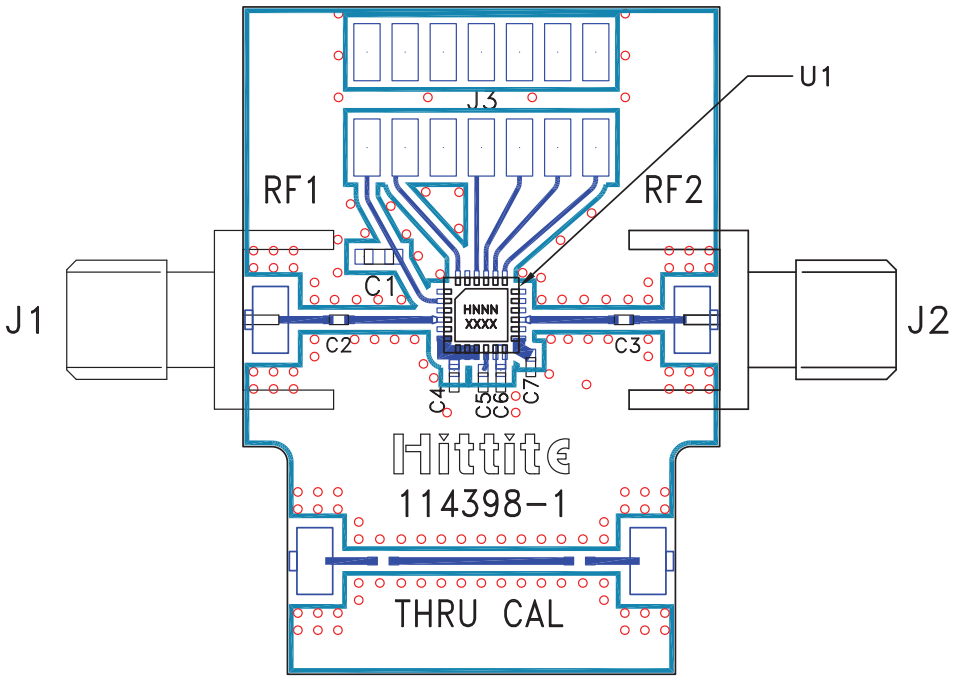
1. LEADFRAME MATERIAL: COPPER ALLOY
2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM. PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC542LP4	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H542 XXXX
HMC542LP4E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	H542 XXXX

[1] Max peak reflow temperature of 235 °C
[2] Max peak reflow temperature of 260 °C
[3] 4-Digit lot number XXXX

Evaluation PCB



List of Materials for Evaluation PCB 114399 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3	14 Pin DC Connector
C1	1000 pF Capacitor, 0603 Pkg.
C2, C3	1000 pF Capacitor, 0402 Pkg.
C4 - C7	330 pF Capacitor, 0402 Pkg.
U1	HMC542LP4 / HMC542LP4E Digital Attenuator
PCB [2]	114398 Evaluation PCB

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.